## Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Lead Free Finish, RoHS Compliant (Note 2)


## Mechanical Data

- Case: POWERMITE ${ }^{\circledR} 3$
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish). e3:
- Polarity: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.072 grams (approximate)
 connected at the printed circuit board.


## Maximum Ratings $@ T_{A}=25^{\circ} \mathrm{C}$ unless otherwise specified

Single phase, half wave, 60 Hz , resistive or inductive load
For capacitive load, derate current by $20 \%$.

| Characteristic | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | VRRM $V_{\text {RWM }}$ $V_{R}$ | 40 | V |
| RMS Reverse Voltage | $\mathrm{V}_{\mathrm{R} \text { (RMS) }}$ | 28 | V |
| Average Rectified Output Current (see also Figure 5) | 10 | 5 | A |
| Non-Repetitive Peak Forward Surge Current <br> 8.3ms Single half sine-wave Superimposed on Rated Load $@ T_{C}=90^{\circ} \mathrm{C}$ | IFSM | 100 | A |
| Typical Thermal Resistance Junction to Soldering Point | $\mathrm{R}_{\theta \text { JS }}$ | 3.2 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Operating Temperature Range | $\mathrm{T}_{\mathrm{J}}$ | -55 to +125 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {STG }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

## Electrical Characteristics $@ T_{A}=25^{\circ} \mathrm{C}$ unless otherwise specified

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Reverse Breakdown Voltage (Note 1) | $\mathrm{V}_{(\mathrm{BR}) \mathrm{R}}$ | 40 | - | - | V | $\mathrm{I}_{\mathrm{R}}=0.5 \mathrm{~mA}$ |
| Forward Voltage | $V_{\text {fm }}$ | - | $\begin{aligned} & 0.48 \\ & 0.45 \\ & 0.59 \\ & 0.56 \\ & \hline \end{aligned}$ | 0.52 <br> - <br> - | V | $\begin{aligned} & I_{F}=5 \mathrm{~A}, \mathrm{~T}_{S}=25^{\circ} \mathrm{C} \\ & \mathrm{I}_{F}=5 \mathrm{~A}, \mathrm{~T}_{S}=125^{\circ} \mathrm{C} \\ & \mathrm{I}_{\mathrm{F}}=10 \mathrm{~A}, \mathrm{~T}_{S}=25^{\circ} \mathrm{C} \\ & \mathrm{I}_{F}=10 \mathrm{~A}, \mathrm{~T}_{S}=125^{\circ} \mathrm{C} \end{aligned}$ |
| Reverse Current (Note 1) | IRM | - | $\begin{gathered} \hline 0.05 \\ 2.5 \end{gathered}$ | $\begin{aligned} & 0.5 \\ & 20 \end{aligned}$ | mA | $\begin{aligned} & \mathrm{T}_{\mathrm{S}}=25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{R}}=40 \mathrm{~V} \\ & \mathrm{~T}_{\mathrm{S}}=100^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{R}}=40 \mathrm{~V} \end{aligned}$ |
| Total Capacitance | $\mathrm{C}_{\text {T }}$ | - | 250 | - | pF | $\mathrm{f}=1.0 \mathrm{MHz}, \mathrm{V}_{\mathrm{R}}=4.0 \mathrm{~V}$ DC |

Notes: 1. Short duration pulse test used to minimize self-heating effect.
2. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.


Fig. 1 Typical Forward Characteristics


NUMBER OF CYCLESAT 60 Hz
Fig. 3 Max Non-Repetitive Peak Forward Surge Current


Fig. 2 Typical Reverse Characteristics


Fig. 4 Typical Total Capacitance vs. Reverse Voltage


Notes: 3. $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {soldering point }}, \mathrm{R}_{\text {өJs }}=3.2^{\circ} \mathrm{C} / \mathrm{W}, \mathrm{R}_{\theta S A}=0^{\circ} \mathrm{C} / \mathrm{W}$.
4. Device mounted on GETEK substrate, $2^{\prime \prime} \times 2^{\prime \prime}, 2$ oz. copper, double-sided, cathode pad dimensions $0.75^{\prime \prime} \times 1.0^{\prime \prime}$, anode pad dimensions $0.25^{\prime \prime} \times 1.0^{\prime \prime}$. R ${ }_{\theta J A}$ in range of $15-30^{\circ} \mathrm{C} / \mathrm{W}$.
5. Device mounted on FR-4 substrate, $2^{\prime \prime \prime} \times 2^{\prime \prime}, 2$ oz. copper, single-sided, pad layout as per Diodes Inc. suggested pad layout document AP02001 which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. $R_{\theta J A}$ in range of $60-75^{\circ} \mathrm{C} / \mathrm{W}$.

Ordering Information (Note 6)

| Device | Packaging | Shipping |
| :---: | :---: | :---: |
| SBM540-13-F | POWERMITE $^{\top} 3$ | $5000 /$ Tape \& Reel |

Notes: 6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## Marking Information



SBM540 = Product type marking code J!" = Manufacturers' code marking YYWW = Date code marking YY = Last digit of year (ex: 02 for 2002)
WW = Week code (01 to 53)
$(\mathrm{K})=$ Factory Designator

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